

Automotive and Industrial Qualified Bluetooth Low Energy Wireless MCUs

Kinetis[®] KW36A/35A, KW36Z/35Z Bluetooth[®] 5 Wireless MCUs with Integrated CAN/CAN FD and LIN Bus

The Kinetis KW36A/35A and KW36Z/35Z wireless MCUs feature AEC Q100 Grade 2 or industrial qualification and the latest Bluetooth technology for superior durability and performance in automotive, industrial and healthcare applications.

OVERVIEW

Based on the Arm[®] Cortex[®]-M0+ core, the Kinetis KW36A/35A and KW36Z/35Z wireless MCUs integrates a Bluetooth Low Energy (BLE) version 5 and Generic FSK radio. The radio supports up to 8 simultaneous secure connections in any master/slave combination allowing multiple authorized users to communicate with the device.

Additionally, the Kinetis KW36 MCU exclusively integrates FlexCAN, enabling seamless integration into a cars in-vehicle or industrial CAN communication network. The FlexCAN module can support CAN's flexible data-rate (CAN FD) for increased bandwidth and lower latency.

TARGET APPLICATIONS

Automotive

- Car access
- Car sharing
- Passive entry/passive start (PEPS) systems
- Tire pressure measurement sensors (TPMS) systems
- Wireless on-board diagnostic functions

Industrial

- Building control and monitoring
- ▶ Fire and safety

Healthcare

- Home and institutional healthcare
- Patient monitoring

KINETIS KW36A/35A AND KW36Z/35Z WIRELESS MCU FAMILY BLOCK DIAGRAM





FEATURES

All MCUs in this family contain an integrated buck DC-DC converter that supports operating voltages from 2.1-3.6 V and significantly reduces the peak current in receive and transmit modes. At the same time, this family delivers an excellent link budget that ensures the longest range of communication and a high immunity to interference.

This family has up to 512 KB Flash memory with ECC and 64 KB SRAM allowing plenty of space for protocol stacks, application profiles and custom user firmware. In addition, the radio can provide the necessary information in order to calculate Time-of-Flight (ToF), Angleof-Arrival (AoA) and Angle-of-Departure (AoD) that can accurately estimate the distance/angle of a remote BLE device to determine its position.

For automotive applications, Kinetis KW36A/35A devices are AEC-Q100 Grade 2 qualified and are provided in a 6 mm x 6 mm QFN package with "wettable" flanks package technology that enables optical inspection of the soldering, reducing cost and increasing reliability.

ENABLEMENT

Take advantage of the robust enablement package that includes the fully certified BLE 5 host and controller stacks, BLE application profiles in source, generic FSK software protocol, RTOS, development tools and IDEs. These tools are designed for use with Kinetis KW36A/35A and KW36Z/35Z MCUs and are fully integrated in the MCUXpresso software and tools.

KINETIS KW36A/35A AND KW36Z/35Z WIRELESS MCU FAMILY FEATURES AND BENEFITS

Features	Benefits		
reatures			
BLE 5 with 8 simultaneous connections	Supports simultaneous secure connections in any master/slave combination		
	Keeps all connections alive for continuous monitoring		
6.3 mA typical Rx and 5.7 mA Tx current with DC-DC activated	Significantly reduces power consumption and extends battery life		
-95 dBm typical BLE sensitivity	High link budget improves range and lowers cost by reducing		
-99 dBm typical generic FSK (at 250 kbit/s)	the need for external power amplifiers		
sensitivity	Integrated balun enables smaller design and reduces system		
+3.5 dBm maximum output power	costs		
Excellent selectivity and blocking	Significantly improves operation in harsh 2.4 GHz environments		
48 MHz Arm [®] Cortex [®] -M0+ core			
Up to 512 KB flash memory with ECC	High-performance, low-power core with adequate memory to run BLE, generic FSK protocol stacks and application		
64 KB SRAM	full bee, generie i ski protocor stacks and application		
AES-128 accelerator	Fast encryption/decryption utilizing hardware security		
True random number generator	algorithms for network commissioning and transmissions of supported protocols		
Buck DC-DC converter working from 2.1 V to 3.6 V	Supports a wide range of batteries from coin-cell to Lithium-ion		
16-bit analog-to-digital converter (ADC)	Supports high performance on chip analog at the MCU level		
6-bit high-speed analog comparator (CMP)	Supports high-performance on-chip analog at the MCU level for sensor aggregation and other sophisticated applications		
	Enables easy integration into automotive in-vehicle and		
CAN/CAN FD and LIN Bus	industrial networks		
7 x 7 mm 48LQFN	Smaller size and low component count reduces cost. The		
6 x 6 mm "wettable" flanks 40QFN	wettable flanks package technology enable optical inspection of the soldering, reducing cost and increasing reliability.		

PART NUMBERS

Part Number	Qualification	CAN FD	2nd UART with LIN	8kB EEPROM	Package
MKW36A512VFP4 MKW36Z512VFP4 MKW35A512VFP4	Automotive Industrial Automotive	Y Y N	Y Y N	Y Y N	6 x 6 40-pin Wettable QFN
MKW36A512VHT4 MKW36Z512VHT4 MKW35Z512VHT4	Automotive Industrial Industrial	Y Y N	Y Y N	Y Y N	7X7 48-pin Laminate QFN

DEVELOPMENT TOOLS

Board Name	Description
FRDM-KW36	Freedom development board for Kinetis KW36/35 MCUs with 2.4 GHz BLE and generic FSK wireless connectivity and CAN/LIN connectivity solutions
USB-KW41Z	USB dongle for sniffer operations for Kinetis wireless MCUs with 2.4 GHz BLE and generic FSK $% \mathcal{A}_{\mathrm{S}}$

www.nxp.com/Wireless/KinetisKW36

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